

#### **LED Driver Datasheet**

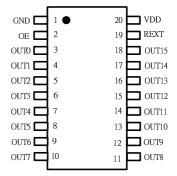
#### 16 channel constant current LED driver

#### **Features**

- 16 constant current sink outputs
- 3 ~ 60mA channel sink current
- 3V to 5.5V supply voltage
- Excellent current sink uniformity channel to channel: < ± 3% chip to chip: < ± 3%
- OE pulse width: 120ns
- Schmitt trigger input
- 165°C thermal shutdown protect
- 5ns output group delay for stagger output
- Maximum output voltage: 17V
- $-40^{\circ}$ C ~  $+85^{\circ}$ C operating temperature

# **Package Type**

• TSSOP 173 mil 20 pin



#### **Product Description**

NU516 is a 16 channels constant current sink driver used for LED lighting. NU516 can sink 16 channels constant current simultaneously by the control of a single OE pin. The sink current of output channels can be set easily by an external resistor Rext. Each output channel can be connected with each other to gain higher current driving capability. With this parallel-able output capability, one NU516 can drive constant current from 3mA to 960mA being used to most types of LEDs.

#### **Terminal Description**

Pin name	Function			
$V_{DD}$	5V/3.3V power supply			
GND	Chip ground pin			
R <sub>EXT</sub>	Current setting resistor			
OE	Output enable			
OUT0 ~ OUT15	Constant current sink terminals			

#### **Applications**

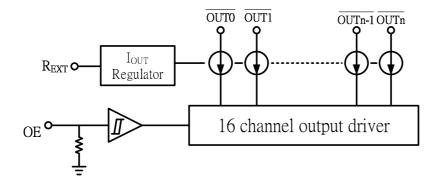
- General LED Lighting
- Decoration lighting for architecture
- LCD back lighting
- Street lamp

#### **Protection Circuit**

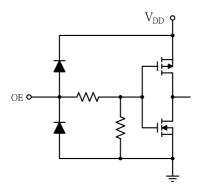
• 8KV output channel ESD protection

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# **Block Diagram**



# **Equivalent Circuits for OE Input**



# Maximum Ratings (T = 25°C)

Characteristic	Symbol	Rating	Unit	
Supply voltage	$V_{DD}$	0 ~ 6.0	V	
Input pin voltage	V <sub>IN</sub>	-0.2 ~ V <sub>DD</sub> +0.2	V	
Output current	I <sub>out</sub>	80	mA/Channel	
Output voltage	V <sub>out</sub>	-0.2 ~ 24.0	V	
Total GND terminals current	I <sub>GND</sub>	1280	mA	
Power Dissipation (On PCB)	PD	1	W	
Thermal Resistance	$R_{TH(j-a)}$	33.3	°C /W	
Junction temperature	Tj	135	°C	
Operating temperature (Ambient)	T <sub>OPR</sub>	-40~+85	°C	
Storage temperature	T <sub>STG</sub>	-55~+150	°C	

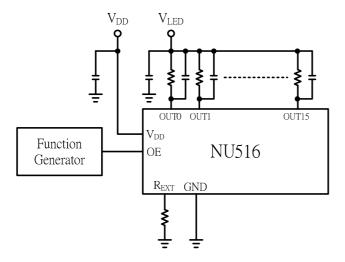
# **Electrical Characteristics and Recommended Operating Conditions**

Characteristic		Symbol	Condition	Min.	Тур.	Max.	Unit	
Supply voltage		$V_{DD}$	Room Temp.	3	5	5.5	V	
Output port sustaining voltage		$V_{OUT}$	-	17	1	24	V	
Output cu	ırrent	$I_{OUT}$	OUTn = 1V	3	-	60	mA	
Output lea	akage	$I_{LEAK}$	$V_O = 7V$ and channel off	-	-	0.5	uA	
Channel curr (Outpu		$\mathrm{dI}_{\mathrm{OUT1}}$	$I_{OUT} = 20$ mA, $V_{OUT} = 1$ V	ı	±1	±3	%	
Center current skew (IC)		$\mathrm{dI}_{\mathrm{OUT2}}$	$I_{OUT} = 20$ mA, $V_{OUT} = 1$ V	-	1	±3	%	
Line regul	Line regulation		$R_{\rm EXT} = 900 \Omega$ , $V_{\rm OUT} = 1  { m V}$	-	±1	±2	%	
Load regu	Load regulation		$R_{\rm EXT} = 900 \Omega$	-	±0.5	±1	%	
Input vol	Input voltage			$0.7V_{DD}$	-	-	V	
Input voi	itage	$V_{ m IL}$		-	-	$0.3V_{DD}$	V	
Thermal p	Thermal protect (Junction temperature)		Half current output	-	135	-	°C	
(Junction tem			All output off	-	165	-		
Pull down resistor (OE)		$R_{PU}$		400	500	700	$\mathbf{K}\Omega$	
	All output "Off"	$I_{\mathrm{DD1(off)}}$	$R_{EXT}$ = Open, all output off	-	1	-	mA	
		I <sub>DD2(off)</sub>	$R_{EXT} = 900 \Omega$ , all output off	-	4	-	mA	
Supply current		I <sub>DD3(off)</sub>	$R_{EXT} = 600 \Omega$ , all output off	-	5	-	mA	
	All output	I <sub>DD1(on)</sub>	$R_{\rm EXT} = 900 \Omega$ , all output on	-	5	-	mA	
	"On"	$I_{DD2(on)} \\$	$R_{EXT} = 600 \Omega$ , all output on	-	6	-	mA	

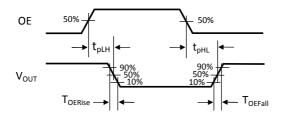
# **Switching Characteristics**

Characteristic	Symbol	Condition	Min.	Тур.	Max.	Unit
Propagation Delay Time (OE from "L" to "H")	t <sub>pLH</sub>	$V_{DD}$ =4V, $V_{OUT}$ =1V, $I_{OUT}$ =120mA, OE= 0V $\rightarrow$ 4V	100	1	250	nS
Output current rising time (OE from "L" to "H")	$t_{OERise}$	$V_{DD}$ =4V, $V_{OUT}$ =1V, $I_{OUT}$ =120mA, OE= 0V $\rightarrow$ 4V	100	-	250	nS
Propagation Delay Time (OE from "H" to "L")	t <sub>pHL</sub>	$V_{DD}$ =4V, $V_{OUT}$ =1V, $I_{OUT}$ =120mA, OE= 4V $\rightarrow$ 0V	100	-	500	nS
Output current falling time (OE from "H" to "L")	t <sub>OEFall</sub>	$V_{DD}=4V$ , $V_{OUT}=1V$ , $I_{OUT}=120$ mA, $OE=4V \rightarrow 0V$	100	-	250	nS

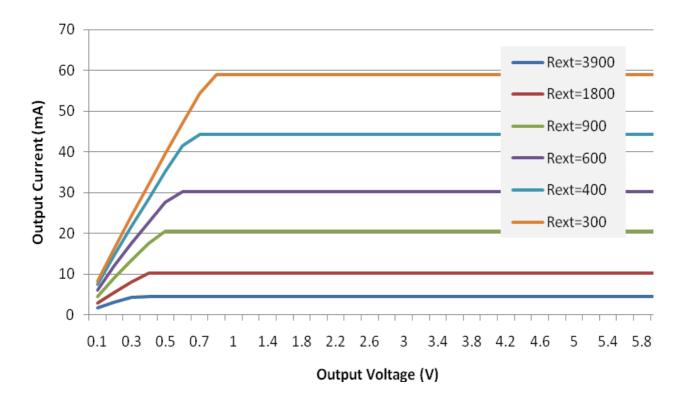
# **Test Circuit for Switching Characteristics**



#### **Timing Waveforms**

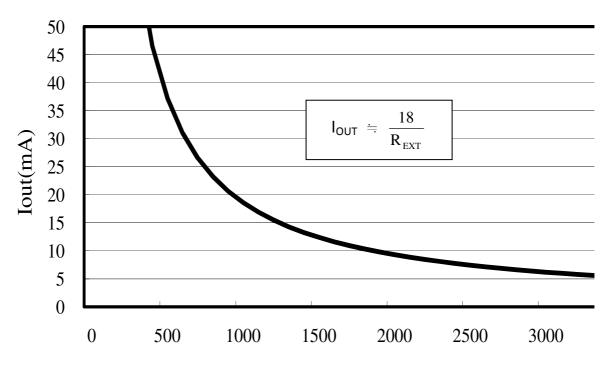


#### I/V curve



# **Output Current Setting**

The output current of each channel of NU516 is set by an external resistor (R<sub>EXT</sub>). The relationship between output current and external resistor is shown in the figure or calculated from the equation following.

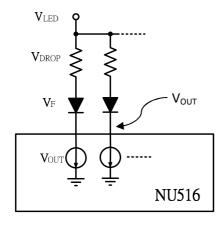


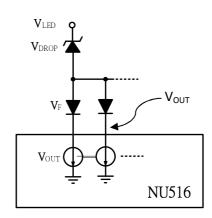
#### **Application Notes**

- In order to maximize the heat dissipation capability and keep the NU516 function normally, the thermal pad under TSSOP package should be soldered to the PCB and connect to the ground net of system. More the ground area, more the heat dissipation capability that NU516 relies on.
- The  $V_{OUT}$  should be as low as possible near the knee point of the output I/V curve to minimize the heat generation from NU516. An external resistors or zener diodes can be used to minimize  $V_{OUT}$  in the output current path. The suggestion  $V_{OUT}$  voltage is between 0.4v to 1v.

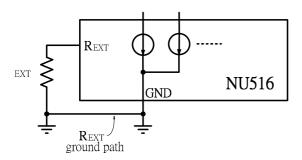
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Ex: 
$$V_{OUT} = V_{LED} - (V_{DROP} + V_F)$$

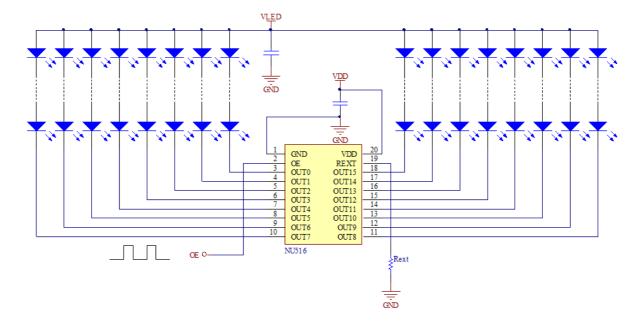


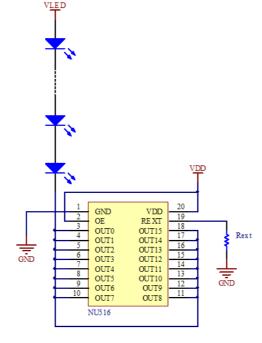


• The R<sub>EXT</sub> ground path should be as short and wide as possible to minimize the chip current skew.



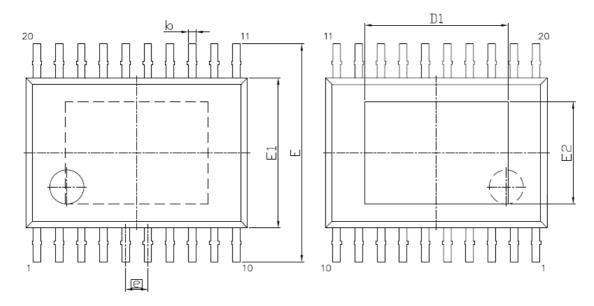
# **Typical Application Circuit**

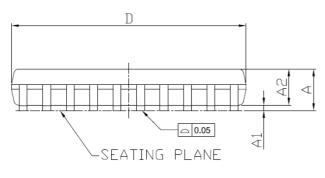


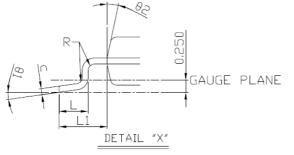


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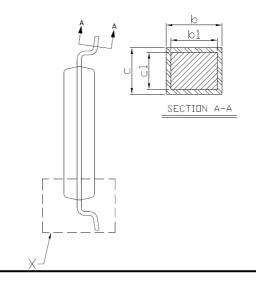
# **Package Dimensions**





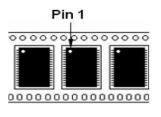


CVMDEI	DIMENSION (MM)			DIMENSION (MIL)		
SYMBOL	MIN.	N□M.	MAX.	MIN.	N□M.	MAX.
Α	-	-	1.20	-	-	47.0
A1	0,00	-	0.15	0.0	-	5.9
A2	0.80	1.00	1.05	31.5	39.4	41.3
b	0.19	-	0.30	7.5	ı	11.8
b1	0.19	0.22	0.25	7.5	8.7	9.8
С	0.09	-	0.20	3,5	-	7.9
⊂1	0.09	-	0.16	3.5	-	6.3
D	6.40	6.50	6.60	252.0	256.0	260.0
D1	3.80	4.00	4.20	149.6	157.0	165.0
Ε		6,40 BS	С		252.0 B	SC
E1	4.30	4,40	4.50	169.3	173.2	177.2
E2	2.60	2,80	3.00	102.3	110.0	118,0
9	0.65 BSC				25.6 BS	С
L	0.45	0.60	0.75	17.7	23,6	29.5
L1	1.00 REF				39,4 RE	F
R	0.127	-	_	5.0	-	-
θ1	0°	-	8°	0°	-	8°
92		12° REF			12° R	EF



**Taping Specification** 

PACKAGE	Q'TY/REEL
TSSOP	2,500 ea



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